1	L Number	Hits	Search Text	DB	Time stamp
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alignment or aligned or align)   near3     EPO; JPO;   DERMENT;   IBM TDB   USPAT   2004/02/18 14:05   USPAT   USPAT   2004/02/18 14:05   USPAT   USPAT   2004/02/18 14:05   USPAT   U					
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9   5561328.URPN.   Chip or ic or die) near5 (positioning or position or positioned or aligning or alignment or aligned or aligning or alignment or placement or alignment or alignment or placement or alignment or alignment or placement or alignme	İ				
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Tem TDB   SPAT;   Us-PGPUB;   EPO; JPO;   DERWENT;   LSPAT;   Us				EPO; JPO;	
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9   130			and (Billoon of Bomiconadotol)		
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11   2703   (sidewall or wall)   (chip or ic or die) near3 (receiving or received or inserting or insertion or alignment) near2 (recess or slot or aperture)   1664   (chip or ic or die) near3 (receiving or received or inserting or insertion) near2   US-PGPUB;   (recess or slot or aperture)   USPAT;   USPAT;   USPAT;   USPGPUB;   (recess or slot or aperture)   EPO; JPO;   DERWENT;   IBM_TDB   USPAT;   USPGPUB;   (recess or slot or aperture)   EPO; JPO;   DERWENT;   IBM_TDB   USPAT;   USPGPUB;   (recess or slot or aperture)   near6 (template or self-aligned or self-alignment or walls or guide or sidewall or ramp)   S824186.pn.   2004/02/18 14:28   2004/02/18 14:32   2004/02/18 14:32   2004/02/18 14:32   2004/02/18 14:32   2004/02/18 14:28   2004/02/18 14:32   2004/02/18 14:32   2004/02/18 14:32   2004/02/18 14:32   2004/02/18 14:28   2004/02/18 14:32   2004/02/18 14:32   2004/02/18 14:32   2004/02/18 14:32   2004/02/18 14:32   2004/02/18 14:32   2004/02/18 14:32   2004/02/18 14:32   2004/02/18 14:32   2004/02/18 14:28   2004/02/18 14:32   2004/02/18 14:28   2004/02/18 14:32   2004/02/18 14:28   2004/02/18 14:32   2004/02/18 14:28   2004/02/18 14:32   2004/02/18 14:28   200					
11   2703   (chip or ic or die) near3 (receiving or received or inserting or insertion or inserted or holding or aligning or alignment) near2 (recess or slot or aperture)   1664   (chip or ic or die) near3 (receiving or received or inserting or insertion) near2 (recess or slot or aperture)   (chip or ic or die) near3 (receiving or received or inserting or insertion) near2 (recess or slot or aperture)   18M TDB   19A T;   18M TDB   19A T;   18M TDB   19A T;				1	
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inserted or holding or aligning or alignment) near2 (recess or slot or aperture)  12		2,03		•	2004,02,10 14.24
alignment) near2 (recess or slot or aperture)  (chip or ic or die) near3 (receiving or received or inserting or insertion) near2 (recess or slot or aperture)  (chip or ic or die) near3 (receiving or received or inserting or insertion) near2 (chip or ic or die) near3 (receiving or received or inserting or insertion) near2 (chip or ic or die) near3 (receiving or received or inserting or insertion) near2 (chip or ic or die) near3 (receiving or received or inserting or insertion) near2 (chip or ic or die) near3 (receiving or received or inserting or insertion) near2 (chip or ic or die) near3 (receiving or received or inserting or insertion) near2 (chip or ic or die) near3 (receiving or received or inserting or insertion) near2 (chip or ic or die) near3 (receiving or received or inserting or insertion) (chip or ic or die) near3 (receiving or received or inserting or insertion) (chip or ic or die) near3 (receiving or received or inserting or insertion) (chip or ic or die) near3 (receiving or received or inserting or insertion) (chip or ic or die) near3 (receiving or received or inserting or insertion) (chip or ic or die) near3 (receiving or received or inserting or insertion) (chip or ic or die) near3 (receiving or received or inserting or					
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received or inserting or insertion) near2 (recess or slot or aperture)  13  106 (chip or ic or die) near3 (receiving or received or inserting or insertion) near2 (recess or slot or aperture) near6 (template or self-aligned or self-alignment or walls or guide or sidewall or ramp)  14  2 5824186.pn.  15  2 ("4990462"   "5091045").PN.  US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT 2004/02/18 14:28	12	1664	•		2004/02/18 14:24
DERWENT;   IBM_TDB   USPAT;   US-PGPUB;   EPO; JPO;   DERWENT;   IBM_TDB   USPAT   U				US-PGPUB;	
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received or inserting or insertion) near2 (recess or slot or aperture) near6 (template or self-aligned or self-alignment or walls or guide or sidewall or ramp)  14 2 5824186.pn.  2 004/02/18 14:32 US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT 2 004/02/18 14:28	*				]
(recess or slot or aperture) near6 (template or self-aligned or self-alignment or walls or guide or sidewall or ramp)  DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT 2 ("4990462"   "5091045").PN.	13	106			2004/02/18 14:28
or self-aligned or self-alignment or walls or guide or sidewall or ramp)  14  2 5824186.pn.  USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB  15  2 ("4990462"   "5091045").PN.  USPAT  2004/02/18 14:28					
or guide or sidewall or ramp)  18M_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB 15  2 ("4990462"   "5091045").PN.  USPAT 2004/02/18 14:32					
14 2 5824186.pn. USPĀT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPĀT 2004/02/18 14:28					
US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT 2004/02/18 14:28	14	_			2004/02/10 14 32
EPO; JPO; DERWENT; IBM_TDB USPAT 2004/02/18 14:28	14	2	2024180.pm.	·	2004/02/18 14:32
DERWENT; IBM_TDB USPAT 2004/02/18 14:28					
15 2 ("4990462"   "5091045").PN.   IBM_TDB   USPAT   2004/02/18 14:28					
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	15	2	("4990462"   "5091045").PN.	_	2004/02/18 14:28
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17	326	(optical) near4 (module or component or ic	USPAT;	2004/02/18 14:43
		or chip or die) near5 (array or matrix)	US-PGPUB;	
		near5 (alignment or aligning or aligned or	EPO; JPO;	
		positioning or placement or positioned)	DERWENT;	
			IBM_TDB	
18	394	(chip or ic or die) near2 (self-alignment or	USPAT;	2004/02/18 14:43
		self-aligning or self-aligned)	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
	1		IBM TDB	
19	25	(chip or ic or die) near2 (self-alignment or	USPAT;	2004/02/18 14:44
		self-aligning or self-aligned) near5	US-PGPUB;	
		(aperture or recess or slot or socket or	EPO; JPO;	
		opening or depression)	DERWENT;	<u>'</u>
			IBM TDB	
20	26	(chip or ic or die) near2 (self-alignment or	USPAT;	2004/02/18 14:44
		self-aligning or self-aligned) near5	US-PGPUB:	, ,
		(aperture or recess or slot or socket or	EPO; JPO;	
		opening or depression or wall or sidewall)	DERWENT;	
			IBM TDB	
21	395	(chip or ic or die or module or component)	USPAT;	2004/02/18 14:46
		near3 (positioning or position or positioned	US-PGPUB;	
		or locating or located or aligning or	EPO; JPO;	
1		alignment or aligned or align) near3	DERWENT;	
		(template or aperture or socket or quide or	IBM TDB	
l i		recess) and (template or aperture or socket	15.1_155	
]		or quide or recess) near3 (metal or		
1		epitaxial)		
22	30	(chip or ic or die or module or component)	USPAT;	2004/02/18 14:49
**	] 30.	near3 (positioning or position or positioned	US-PGPUB;	2004/02/18 14:49
		or locating or located or aligning or	EPO; JPO;	
		alignment or aligned or align) near3	DERWENT;	
		(template or quide or wall or sidewall)	•	
			IBM_TDB	
		near3 (metal or epitaxial or aluminum or		
		titanium or tungsten or nickel or chromium)		L